US Full Image			고진성					
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2	បន	6621660 B2	20030916	10	Thin film magnetic head	360/126	360/123	
3	MO	2054458 A2	20020711	27	METHOD FOR THE MANUFACTURE OF MICRO STRUCTURES	and the state of t		<u>.</u>
4	បន	6540928 B1	20030401	10	Magnetic pole fabrication process and device	216/22	205/119; 216/39;	!
5	បន	6524491 B1	20030225	13	Double plate-up process for fabrication of composite	216/22	216/38; 216/57;	**************************************
6	បន	5802700 A	19980908	25	Method of making a planarized thin film	29/603.14	29/603.15; 29/603.18;	
7	បន	6547975 B1	20030415	17	Magnetic pole fabrication process and device	216/22	204/192.1; 427/251	+
8	υs	6521335 B1	20030218	:	Method of fabricating a submicron narrow writer pole	428/336	360/126; 428/692;	! ! !
g	υs	5885750 A	19990323	8	Tantalum adhesion layer and reactive-ion-etch process	430/314	257/E21.535; 257/E21.509;	
10	JP A	2003017474	20030117	12	THIN-FILM PATTERNING METHOD, AND MANUFACTURING METHODS OF	and that the sear the control of the sear the search of the search of the search that control of the search of the	E or Maria from the of Nasid April A	
11	υs	6100014 A	20000808	:	Method of forming an opening in a dielectric layer	430/314	430/317; 430/324;	<del> </del> 
12	បន	5665251 A	19970909	:	RIE image transfer process for plating	216/22	216/40; 216/47;	! ! !
13	បន	4803181 A	19890207	7	Process for forming sub-micrometer patterns	438/696	148/DIG.111; 148/DIG.137;	^ i i i
14	បន	4502914 A	19850305		Languagarang kanggang mengang keranggan panggang arap menganggang keranggang keranggang keranggang kerang mer	438/424	204/192.3; 204/192.32;	†
15	បន	6423475 В1	20020723	9	Sidewall formation for sidewall patterning of sub	430/314	257/E21.314; 430/313;	
16	បន	5928967 A	19990727	6	Selective oxide-to-nitride etch process using C.sub.4	438/740	257/E21.252; 257/E21.579;	i i i
17	บร	4871630 A	19891003	5	å 1651 av 1651 far i 1650 av 1651 av 1	430/14	216/46;	

L	Hits	Search Text	DB	Time stamp
Number		140716301		_
1	10	"4871630"	USPAT; EPO; JPO	2003/11/04 10:45
2	5	("4234362"   "4256514"   "4259369"	USPAT	2003/11/04
-		"4600686"   "4778739").PN.		10:46
-	9	howard with zolla.in.	USPAT;	2003/10/30
	135	thin add film with magnetic and	US-PGPUB USPAT;	17:51 2003/10/30
-	133	thin adj film with magnetic and photolithographically	EPO; JPO	18:47
_	16		USPAT;	2003/10/30
		photolithographically) and trench	EPO; JPO	17:52
-	16		US-PGPUB	2003/10/30
_	21	photolithographically 29/\$.ccls. and (thin adj film with	USPAT;	18:03 2003/10/30
	-	magnetic and trench and etch\$3)	EPO; JPO	18:48
-	213		USPAT;	2003/10/30
		and etch\$3	EPO; JPO	18:51
_	2	438/696,947.ccls. and trench and etch\$3 and seed adj layer	USPAT; EPO; JPO	2003/10/31
-	672	438/\$.ccls. and trench and etch\$3 and	USPAT;	2003/10/31
		seed adj layer	EPO; JPO	12:37
-	426		USPAT;	2003/10/31
		seed adj layer) and plat\$3 and (strip\$4 remov\$3)	EPO; JPO	12:00
_	77	· · ·	USPAT;	2003/10/31
		seed adj layer) and plat\$3 and (strip\$4	EPO; JPO	12:00
	_	remov\$3)) and side adj wall		0000 /10 /01
_	4	29/\$.ccls. and trench and etch\$3 and seed adj layer and side adj wall and plat\$3	USPAT; EPO; JPO	2003/10/31
		and (remov\$3 strip\$4)	EFO, UPO	14.71
-	11	216/\$.ccls. and trench and etch\$3 and	USPAT;	2003/10/31
		seed adj layer and side adj wall and	EPO; JPO	12:42
_	21	plat\$3 and (remov\$3 strip\$4) 205/\$.ccls. and trench and etch\$3 and	USPAT;	2003/10/31
	2.1	seed adj layer and side adj wall and	EPO; JPO	12:44
		plat\$3 and (remov\$3 strip\$4)		
-	2	360/\$.ccls. and trench and etch\$3 and	USPAT;	2003/10/31
		seed adj layer and side adj wall and plat\$3 and (remov\$3 strip\$4)	EPO; JPO	12:45
-	36		USPAT;	2003/10/31
		etch\$3 and plat\$3 and trench	EPO; JPO	12:46
-	29	("4209349"   "4358340"   "4377437"	USPAT	2003/11/03
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		"4552833"   "4601778"   "4613398"		
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	1	2054458.URPN.	USPAT	2003/11/03
_	29	("4209349"   "4358340"   "4377437"	USPAT	2003/11/03
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_	13	("5267112"   "5435053"   "5606478"	USPAT	2003/11/03
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		"6131271"   "6188544"   "6191918"		
_	5	"6278590").PN.   ("4803181"   "4871630"   "5895740"	USPAT	2003/11/03
		"5922516"   "5958800").PN.		15:24

_	84	4502914.URPN.	USPAT	2003/11/03
			•	15:25
_	75	thin adj film and head and trench and	USPAT;	2003/11/03
		plat\$3 and seed adj layer	EPO; JPO	16:03
-	31	pole with tip and trench and plat\$3 and	USPAT;	2003/11/03
	V	seed and etch\$3	EPO; JPO	16:04
-	5	5885750.URPN.	USPAT	2003/11/03
				16:22
-	6	("4315985"   "4919768"   "4927505"	USPAT	2003/11/03
		"5126016"   "5151168"   "5591480").PN.		16:22
-	11	5928967.URPN.	USPAT	2003/11/03
ì				16:40
-	29	("4209349"   "4358340"   "4377437"	USPAT	2003/11/03
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		"6100014"   "6110637").PN.		